Deformation mechanisms during severe plastic deformation of a Cu-Ag composite

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Abstract. A Cu-37at%Ag composite was produced by high-pressure torsion processing of elemental Cu and Ag powders at room temperature. The initial micrometer-sized powder particles were compressed directly in the high-pressure torsion tool and subsequently deformed to different strain levels. The microstructural evolution was studied in detail by scanning and transmission electron microscopy and synchrotron X-Ray measurements, and related to the mechanical properties by microhardness and nanoindentation measurements. The HPT process led to an alignment of Cu and Ag into a lamellar composite microstructure. With increasing applied strain the Cu and Ag lamellae were continuously thinned and simultaneously an ultrafine-grained microstructure was formed in the separate Cu and Ag lamellae. When the lamella spacing reached values lower than the respective grain sizes inside the lamellae, a further lamella thinning occurred causing a significant hardness increase of the composite. At lamella spacings below 50 nm deformation started to localize in 150-300 nm broad shear bands, which surprisingly exhibited no softening. Instead, the steady formation of new shear bands aided to transform the lamellar structure into a

nanocrystalline equi-axed microstructure and additionally rotated the lamellar matrix towards the shear plane. This process led to an additional refinement of the alloy and a hardness increase until a constant hardness level was obtained. Combined analyses by synchrotron X-ray and transmission electron microscopy measurements revealed that, after reaching the saturation microhardness level, mechanical mixing of Cu and Ag occurred in the shear bands, which can be attributed to the enormous strains accommodated in the shear bands. Due to the localized deformation by shear bands, structural and chemical homogenization of the alloy was not achieved even at very high applied strains. The final microstructure was composed of nanocrystalline single-phase supersaturated regions embedded in a residual nano-lamellar matrix.

Key words: shear band; supersaturated solid solution; nanocrystalline; high-pressure torsion; severe plastic deformation

1. Introduction

Nanocrystalline composites are a promising class of materials for technical applications because of their high structural and thermal stability compared to single-phase materials. For instance, the copper based metal matrix composites used as conductors for pulsed high field magnets [1–4] require high thermal and electrical conductivity with simultaneous high strength. These superior characteristics are attained with the introduction of phase boundaries. Extraordinary mechanical and physical properties of Cu-Ag composites were first reported in vapor-quenched [5] and wire drawn alloys [6]. The developments in wire drawn Cu-based alloys have shown an extreme increase in tensile strength [2,4,7].

Several efforts were made in the past years to understand how interface structure and phase spacing influence the mechanical properties [8–10]. The extensive studies on layered fcc-bcc Cu-Nb composites showed that the fundamental nature of deformation mechanism changes with decreasing layer thickness. For layer thicknesses larger than 100 nm conventional dislocation pile-up model could explain the observed Hall-Petch strengthening; however, at layer thicknesses of few tens of nanometer confined layer slip becomes important. Further reduction in layer thickness to several nanometers promote the dislocations to cross the interfaces, leading to strong strain localization [11]. Besides the phase spacing the characteristics of the interfaces can also influence the mechanical properties [8,12]. Finite element simulations have shown that the interface structure and associated texture evolution can affect the deformation mechanisms, in particular the formation of shear bands [13–15], which is a common feature in severe plastic deformation (SPD) processed Cu-Ag alloys [16,17].

Another interesting aspect of immiscible material systems like Cu-Ag is the formation of supersaturated solid solutions and amorphization during severe plastic deformation. Early studies on the ball milling of Cu-Ag system have shown that supersaturated solid solutions can be obtained over the whole composition range [18]. Although, several hypothesis were proposed to explain the mechanism of supersaturation and amorphization [15-20], due to the undefined applied strain a direct correlation between deformation-induced changes and the material state remained unclear [19]. In order to overcome this constraint other SPD processes like accumulative roll bonding and high pressure torsion (HPT) have been used in recent years [17,20–23]. The HPT technique is especially attractive due to the possibilities

of better controlled processing parameters tunable in a wide range of temperature, pressure, strain rate and applied strains.

The HPT deformation of cast Cu-Ag alloys have shown that the starting microstructure can strongly influence the deformation behavior. For inhomogeneous cast structures, which are composed of single phase Cu- or Ag-rich regions and eutectic phases, deformation leads to inhomogeneous evolution of the microstructure and a strain hardening behavior different from that of single-phase alloys [16]. In contrast to the cast microstructures, HPT deformation of Cu and Ag powders provides more homogeneous initial microstructures over the complete range of composition [24].

In the present study we address these issues by HPT deformation of Cu-37at%Ag elemental powders. The initially micrometer-sized particles facilitated investigations on the deformation processes over a wide range of structural length scales. Samples deformed to different strain levels were used to study fundamental deformation mechanisms and their corresponding influence on the microstructure and mechanical properties.

2. Experimental

The commercially pure powders of Cu and Ag (99.97%, 625 mesh and 99.99%, 500 mesh, from Alfa Aesar), with a particle size of about 20 to 50 μm , were mixed to obtain a Cu-37at%Ag composition. The powders were filled directly into the steel anvils and consolidated in the HPT tool. The HPT processing was performed with an applied pressure of 7.5 GPa and a rotational speed between 0.2 and 0.6 rotations/min at room temperature (RT). Samples

were deformed between 1 and 100 rotations, the corresponding applied shear strain γ is calculated with

$$\gamma = \frac{2\pi r}{t} n, \quad (1)$$

where r is the radius, t the thickness of the disk and n is the number of rotations. The resulting disks were 8 mm in diameter with a thickness between 0.45 and 0.6 mm. Detailed information on the HPT process used in this study can be found elsewhere [25]. During HPT processing the specimen and the anvils were cooled with compressed air to avoid heating of the sample. Due to uncertainties in the sample preparation process of samples (exact radius and exact thickness of the sample of the investigated area), for the calculated shear strains only approximate values can be given.

Microstructural investigations were performed with a Zeiss Leo 1525 scanning electron microscope (SEM), a Philips CM12 operated with 120kV and an image-side C_s -corrected JEOL JEM-2100F operated with 200 kV transmission electron microscopes (TEM). The SEM samples were prepared by conventional polishing with diamond paste and colloidal silica and a final polishing with Buehler Vibromet. The TEM samples were prepared by standard dimple grinding with subsequent ion milling. Special care was taken to avoid any heating of the sample during preparation.

The local deformation processes were analyzed with a split HPT disk as shown in Figure 1 [26]. The HPT disks, previously deformed to 5, 10, 50 and 100 rotations, were cut at a radius of about 2 mm as indicated in Figure 1a (which corresponds to applied shear strains of $\gamma \sim 18, 125, 250, 1250$ and 2500 , respectively). The cross-section surface was polished and

100 × 100 μm grids were engraved into the polished surface by focused ion beam (FIB) technique (see Figure 1b). At least three grids were made across the thickness of each disk. After FIB cutting, a matching counterpart of an HPT disk made of pure Cu was put together with the sample into the HPT tool and further deformed for 5 or 15°, corresponding to applied shear strains of $\gamma \sim 0.33$ or 1, respectively (see Figure 1c). Before and after these additional HPT deformation steps the displacement of the FIB markers was analyzed with SEM.

Synchrotron X-ray diffraction (XRD) experiments were performed at the PETRA III P07 beamline at the DESY Photon Science facility (Hamburg). The diffraction measurement was conducted on samples deformed to $\gamma \sim 190, 380, 1900$ and 3800 using a beam energy of 111 keV. The primary and secondary slit of $0.5 \times 0.5 \text{ mm}^2$ and $0.7 \times 0.7 \text{ mm}^2$, respectively were used to improve the microstructure statistics. The measured transmission diffraction patterns were analyzed with FIT 2D software [27]. A single peak analysis of 111 peaks of Cu, Ag and the supersaturated phase [28] was performed for estimation of coherent domain size and root mean square (RMS) strain. The diffraction pattern of CeO₂ (NIST standard reference 674b) was used as reference for instrumental broadening.

Vickers hardness measurements were performed with a Buehler Micromet 5100 using a maximum load of 500 gf along the cross section of the HPT disk in distances of 250 μm each. Local mechanical properties at room and elevated temperatures were investigated by nanoindentation testing carried out with a platform Nanoindenter G200 (Keysight Tec). All indentations were performed with three-sided Berkovich pyramids (for room temperature testing: diamond; for high temperature testing: sapphire), tip shape and frame stiffness calibrations were performed with Fused Silica in a regular period of time according to the

Oliver Pharr method [29]. Further, a continuous stiffness measurement unit (CSM) was used to collect depth dependent mechanical data (hardness and modulus), by measuring the contact stiffness continuously over indentation depth by superimposing a sinusoidal load signal (standard parameter: 45 Hz, 2 nm oscillation amplitude). Tests were performed in load controlled mode (max. load: 1 mN; Loading Time: 5 s) for small scale mechanical properties mapping as well as in constant strain-rate mode (max. indentation depth: 2500 nm; standard indentation strain-rate: 0.05 s^{-1}) for bulk properties of the different regions. Hardness and Young's Modulus (poisson ratio 0.32) were calculated according to Oliver-Pharr without considering pile-up influences. A significant influence of an indentation size effect can be excluded due to the nanocrystalline microstructure. In addition and for a further understanding of the contributing thermally activated deformation processes, nanoindentation strain rate jump test under ambient conditions (23-28 °C room temperature) [30] and at elevated temperatures (100 – 300 °C) [31] were performed on a set of selected samples. High temperature (HT) testing was realized by a Surface Tec (Hückelhoven, Germany) laser heating unit, which allows the individual heating control of tip and sample. In the case of HT testing, strain rate jump tests were performed at several temperatures during heating to capture any effect on the deformation behavior due to the annealing. Abrupt strain rate changes were applied every 500 nm indentation depth in a repetitive manner between 0.05 , 0.005 and 0.001 s^{-1} for RT and between 0.05 , 0.01 and 0.005 s^{-1} for HT testing.

3. Results

3.1 Microstructural and hardness evolution

A comparison of the Vickers hardness evolution with applied strain, Figure 2, showed a strong hardness increase in the Cu-37at%Ag (Cu37Ag) composite, compared to pure Cu (powder and bulk oxygen-free high-conductivity (OFHC) Cu) and pure Ag (powder). The hardness of samples deformed to 7, 20, 50 and 100 rotations were measured in order to cover a wide range of applied strains. As the powders were directly compacted in the HPT tool, it required an applied strain of about $\gamma \sim 10$ to fully bond the particles together. The hardness profile reflected the general characteristic of immiscible composite material systems [23,24]. Three distinct stages in the hardening behavior can be clearly distinguished for $\gamma > 10$. Between $\gamma \sim 10$ and 100 the hardness increased slightly from about ~ 160 HV to ~ 210 HV. This was followed by a strong hardness increase up to $\gamma \sim 500$. At $\gamma \sim 500$ the hardness saturated to a maximum hardness level of ~ 342 HV. The bulk Cu had a significant lower saturation hardness (~ 150 HV) compared to the consolidated Cu powder (~ 230 HV). Pure Ag showed a saturation hardness of ~ 110 HV without any significant difference in the hardening behavior between powder and bulk material.

In the following section the microstructural evolution in the different hardness regimes are described sequentially. After one rotation ($\gamma \sim 18$ at a radius of 2 mm) a lamellar structure evolved (Figure 3a) with alternating Cu and Ag bands, appearing in dark and bright contrast, respectively. A mean lamella thickness of 740 nm was estimated from a line interception method, however, the lamella thickness distribution is very broad ranging from well below 100 nm to several micrometer. This is a result of the broad initial particle size distribution,

possible particle clustering and the imperfect distribution of Cu and Ag particles after the powder mixing process, causing that strong structural inhomogeneities were present at the beginning. Inside the Cu and Ag lamellae an ultrafine-grained (UFG) structure was formed. As noted in a previous study [24], Ag reaches the saturation hardness and microstructure at much lower applied strains than Cu. When the shear strain was increased further, the separate Cu and Ag lamellae were continuously thinned and at strain of $\gamma \sim 190$, both, also Cu reached the corresponding saturation hardness and UFG microstructure of the bulk material, with sizes between 200 and 300 nm. At this hardness level first shear bands, oriented at $\sim 30^\circ$ to the horizontal shear plane, appeared in fine-lamellar regions (Figure 3b), while micrometer-sized Cu and Ag lamellae were still present at other regions (top and bottom area of the image in Figure 3b). At higher applied strains ($\gamma \sim 380$) the number of shear bands increased (Figure 3c). However, the measured shear band angles tend to decrease with increased shear strain (from $\sim 30^\circ$ measured at the very first shear bands to below 15° measured at $\gamma \sim 380$). Thus the shear bands caused a rotation of the lamellae compared to the parallel alignment at lower applied strains (compare Figure 3a and c).

Further insights are provided by TEM: at a strain of $\gamma \sim 190$ banded regions were observed with a wide range of lamella spacings between 100 nm (see scanning TEM (STEM) bright-field (BF) image in Figure 4a) to few micrometers (see SEM in Figure 3b). Moreover, larger orientation changes were observed along longitudinal section of thinner lamellas (see contrast changes in Figure 4a) while in the transverse section the lamellae substructures were only observed for lamella spacings larger than 50 nm. It must be noted, that the SEM images yield larger lamellae spacings than the spacing revealed by TEM (compare Figure 3b and

Figure 4a) due to the limited resolution of the SEM. At a strain of $\gamma \sim 380$ numerous shear bands occurred, one example is shown in the micrograph in Figure 4b. The shear band is about 300 nm wide and runs through the nano-lamellar/UFG matrix. In STEM BF no distinct grain structure could be identified in the shear band, only small contrast variations indicate the very small grain size. The STEM high-angle annular dark-field (HAADF) imaging combined with EDX measurements revealed chemical variations in the shear band (see Figure 4c). With increasing applied strain the number of shear bands increased, as seen in Figure 4d, $\gamma \sim 1900$ and Figure 4e, $\gamma \sim 3800$. The shear bands showed no intense broadening and no apparent changes in their microstructure. The lamellar regions continue to refine and chemical variations strongly decrease as found by EDX line scans in Figure 4f. In Figure 5a, at $\gamma \sim 3800$, two regions can be distinguished, a dual-phase lamellar in the upper part of the image and a shear band in the lower part. The corresponding selected area diffraction (SAD) patterns (Figure 5b, the areas contributing to the diffraction patterns are roughly marked by circles) were analyzed using the profile analysis of SAD (PASAD) plug-in for Digital Micrograph [32]. The azimuthal integration given in Figure 5c shows clear differences between the lamellar region, where fcc rings from Cu and Ag were present, and the shear band region, where only one set of fcc rings was observed, implying the formation of a single-phase supersaturated solid solution. In both, single- and dual-phase regions, the grain structure is extremely refined and textured, with non-uniform intensities along the diffraction rings.

The presence of this supersaturated phase was also confirmed by synchrotron XRD measurements, see Figure 5d. Table 1 lists the lattice parameters, coherent domain sizes and

inhomogeneous RMS strains calculated from single peak analysis, which was performed on samples deformed to 5, 10, 50, and 100 rotations, corresponding to applied strains of $\gamma \sim 190$, 380, 1900 and 3800, respectively. The lattice parameters of Cu and Ag changed after 50 rotations, indicating the incorporation of Ag and Cu atoms, respectively. Additionally the supersaturated phase appeared, with a lattice parameter of ~ 0.38 nm corresponding to 66 at% Ag. The coherent domain sizes of Cu and Ag reduced continuously with increased applied strain, consistent with SEM and TEM investigations, while the RMS strain, which represents the amount of defects in the lattice, became significant after 50 rotations ($\gamma \sim 1900$). Once the supersaturated phase was formed, it showed no significant increase in coherent domain size and the RMS strain was significantly larger than for Cu and Ag. It is interesting to note that the RMS strain of the supersaturated phase reduced with increasing deformation at 100 rotations ($\gamma \sim 3800$).

3.2 Local deformation behavior

At applied shear strains of $\gamma \sim 125$ (Figure 6a), deviations from ideal shear deformation were observed, revealed by many steps in the inclined FIB grid. Detailed imaging of the markers (Figure 6b) showed that the deformation was more homogeneous in regions with a very fine lamellar structure. In other regions, with coarse Cu and Ag lamellae (width of $> 1 \mu\text{m}$), strong localized deformation was observed. At $\gamma \sim 250$, although the hardness has not reached the saturation level (see hardness plot in Figure 2), many shear bands were observed, as can be seen on the FIB grid in Figure 6c. Two shear bands, which contributed strongly to the accommodation of the applied shear strain, are marked with arrows. Between shear bands the FIB lines are vertical, indicating that the material remained nearly undeformed (Figure

6d). These micrographs suggest that not all shear bands were operating simultaneously (one inactive shear band is indicated by an arrow in Figure 6d). Additionally, besides the shear bands, there were also regions, which deformed by uniform shear, shown by the uniform inclination of the FIB markers in Figure 6e. At higher applied strains ($\gamma \sim 1250$), when the hardness plateau was reached, the whole sample was refined by shear bands. In Figure 6f and 6g two FIB grids are presented exemplarily. A combination of shear bands and homogenous deformation was observed in a fine lamellar microstructure in Figure 6f. The FIB markers were inclined at different angles suggesting variations in the amount of accommodated strain for different regions. In contrast to Figure 6f, the FIB grid in Figure 6g showed a region, which deformed mainly by shear bands. As indicated by arrows the grid was displaced at three positions, where shear bands seem to concentrate. The area in between these bundles remained undeformed, which can be seen on the vertical position of the FIB lines. At a shear strain of $\gamma \sim 2500$, very few regions deformed by uniform shear are visible indicating that shear banding is the dominant deformation mechanism (see Figure 6h).

3.3 Nanoindentation experiments

As the single-phase regions in samples deformed to 100 rotations ($\gamma \sim 3800$) were too small to probe with nanoindentation, a sample deformed to extremely high strains (300 rotations or $\gamma \sim 11300$), which showed large single- and dual-phase regions, was chosen. Several nanoindentation maps (one RT example is shown in Figure 7a) and strain rate jump tests were performed at RT, 70, 100, 150 and 200°C. At RT the hardness difference between single-phase and dual-phase regions was very small, measurements at elevated temperatures showed that exceeding 70°C the hardness drops continuously, see Figure 7b (mean values of

minimum 4 measurements). It must be noted that phase decomposition starts at 100°C, but grain growth not until 250°C, which was confirmed by TEM investigations with *in-situ* and *ex-situ* annealing experiments. The decrease in hardness is somewhat stronger in the dual-phase regions than in the single-phase regions. Strain rate jump tests revealed a small strain rate sensitivity, but no pronounced difference between single- and dual-phase regions was observed, see hardness data in Figure 7c (the Young's modulus is shown in the inset).

4. Discussion

In pure metals and single-phase alloys HPT deformation leads to a microstructural refinement accompanied by intense hardening until an equilibrium of fragmentation and restoration processes is reached, which is typically between $\gamma \sim 10-30$, accompanied with a constant hardness in this regime [33]. However, in immiscible material systems, as in the present study, a more complex fragmentation and hardening behavior is observed. By studying the microstructural changes, the hardness evolution can be divided in four regimes, as indicated schematically in Figure 8 (labeled A to D). In the following section the different hardness regimes are discussed concerning their prevailing deformation mechanisms during HPT processing.

4.1 Deformation at strains $\gamma < 190$ (regime A and B)

In the first stage of hardening, labeled as regime A in Figure 8, a simultaneous thinning of the lamellae and a grain refinement inside the Cu and Ag lamellae occurred. Due to the fragmentation and distribution of the natural oxide layer of the Cu powder, which leads to stabilization of a finer grain structure [34], the Cu powder showed more pronounced

hardening compared to bulk high purity bulk Cu, as seen in the hardness plot in Figure 2. The oxide layer caused a delay of saturation in grain size and in hardness as well. The Ag powder instead reached a steady state at strains of $\gamma \sim 10$, implying that as soon as the powder particles were sufficiently bonded together to obtain a dense sample, the Ag phase had reached the saturation grain size, independent of lamella spacing (see also EBSD data in Reference [24]). Thus, in the first stage of hardening, Ag showed no change in grain size, while Cu continued to refine, causing a hardness increase up to an applied strain of $\gamma \sim 100$. The basic mechanisms leading to the saturation grain structure were similar as in pure metals, namely the formation of dislocation cells and cell blocks, which gradually transform into an UFG structure [33]. In lamellae, which already reached the saturation microstructure (complete Ag phase and part of Cu phase), the grain size is maintained by grain boundary mediated mechanisms [35].

The split samples, see Figure 6a and b, showed that larger residual lamellae deformed stronger compared to fine-lamellar regions, leading to a homogenization of the structural sizes. At a strain of $\gamma \sim 100$ the lamella spacing in some regions reduced below the respective saturation grain size of the Cu and Ag phases (which is about 150 to 250 nm), with only one grain across the width of the lamella (see STEM image in Figure 4a). Then further uniform reduction of Cu and Ag phase spacing, referred to as dual-phase refinement (regime B in Figure 8), occurred. Simultaneously Cu reached the saturation grain size. This refinement led to further increase in hardness until a critical phase spacing is reached and shear localization set in.

4.2 Deformation at strains $\gamma > 190$ (regime C and D)

At applied shear strains of $\gamma \sim 190$ the first shear bands were observed, marking the beginning of regime C (see Figure 8), which ends with reaching the saturation hardness regime D at $\gamma \sim 500$. As shown in split samples in Figure 6d to h, the deformation is realized by a combination of uniform shear of the lamellae and localized shear bands from $\gamma \sim 190$ up to $\gamma \sim 1250$. The characteristics of the shear bands formed in regime C and D will be discussed regarding their impact on microstructural changes and their contribution to the accommodation of the imposed shear strain.

4.2.1 Shear bands in regime C

Extensive studies in the past have shown that shear band formation is primarily dictated by very low hardening rates or lamellar structures, such as heavily twinned alloys or lamellar dual-phase composites [36–42]. Detailed investigations on Cu-Al [37,40] and α -brass [43] have shown that local lattice bending and/or necking of twin lamellae can provide necessary inhomogeneities which act as precursors to the shear bands. On the other hand Jia et al. [44] suggested that the presence of wide grain size distributions can facilitate deformation localization in larger grains and thus initiate shear bands to accommodate the macroscopic strains. For the Cu37Ag powder composite, an inhomogeneous microstructure was present from the beginning (Figure 3b) due to the broad particle size distribution and particle clusters and shear bands were observed to initiate only at thinner lamellae, see Figure 3b.

At a certain point new sets of shear bands are nucleated to accommodate the imposed strain, this caused the lamellae to rotate out of the HPT shear plane with increasing strain.

Nanoindentation measurements (see Figure 7) showed that the hardness difference between single-phase shear band regions and remaining lamellar regions is very small. Because the shear band structure shows no changes with increasing applied strain, it can be assumed that the hardness in the shear bands formed in regime C have the same hardness as the shear bands in regime D. A hardening in the shear bands was suggested by Blicharski et al. in austenitic steel [41], and could explain why shear bands stop to operate (see Figure 6e) and additionally promote the continuous formation of new shear bands in regime C, when the surrounding matrix material is still nano-lamellar or UFG (see Figure 4b). Thus the density of shear bands increases with subsequent deformation. Additionally, the lamella spacing decreases with increase in strain, as seen in micrographs, and also the coherent domain size of Cu and Ag reduced continuously; however, the RMS strain did not show any significant change. Thus, the accumulated deformation was also accommodated by thinning of lamellae. The steady formation of shear bands and the consequent rotation of lamellae blocks to an inclined angle together with further co-deformation of lamellar regions maintained the applied strain. The continuous transformation of lamellar regions into a nanocrystalline microstructure and additionally a further refinement of the lamellae leads to a strong hardening from ~230 HV at $\gamma \sim 190$ to the maximum of ~342 HV in the hardness saturation regime. The development of a shear band network leading to lamella rotation accelerates the refinement of the microstructure. Moreover, the structural inhomogeneities leveled out with increasing strain, because coarser lamellae deform stronger compared to thinner lamellae. At an applied strain of about 500 the hardness saturation regime was reached (equivalent to regime D in Figure 8). The structure at this point is composed of many lamella blocks inclined to the HPT shear

plane, separated by shear bands with a nanocrystalline microstructure. Larger retained lamellae are not present anymore.

4.2.2 Shear bands in regime D

At $\gamma > 1000$, the hardness value is saturated and a supersaturated phase appeared. The XRD measurements at $\gamma \sim 1900$ showed very fine coherent domain size and large RMS strain, suggesting massive accumulation of defects. Interestingly, the RMS strain of the supersaturated phase was much larger than the one of the Cu and Ag lamellae. Moreover, the chemical mixing was observed in both Cu (~ 5 at% Ag) and Ag (~ 7 at% Cu) (see table 1). With increasing applied strain a reduction in shear band angle from 30° to 10° was observed (see Figure 3 and 6). So in regime D a limited number of shear bands were running nearly parallel to the macro shear plane of the HPT deformation (Figure 6h and i), and accommodated most of the imposed shear strain. In these shear bands enormous shear strains were realized, in single shear bands they can exceed levels of $\gamma > 10$ at global applied strains of $\gamma < 1$. Taking for example the shear band in Figure 6e, which caused a shift of the FIB marker by $3.3 \mu\text{m}$, and taking a shear band thickness of 300 nm (as seen in TEM images in Figure 4), the calculated shear strain γ is about 11 (at a global applied strain of 0.35). Hence 30 nm grains or lamellae would refine to below 3 nm in this shear band (according to $d = \frac{d_0}{\gamma}$ [45]). This led to massive chemical mixing and the formation of a single-phase supersaturated solid solution inside the shear bands. Surprisingly, the global composition is attained in the new supersaturated solid solution, which showed a corresponding lattice parameter of $\sim 0.38 \text{ nm}$. At very high strains the grain size of the lamellar matrix approaches the grain size of the shear band (see Figure 5a and table 1). Very similar hardness levels of these different

microstructural states caused a simultaneous deformation by shear bands and uniform shear of lamellar regions. Thus mechanical mixing occurred in the shear bands, where extremely high strains are accommodated, but in addition also in lamellar regions, when the phase spacing reached a critical limit of 5 nm and less (see table 1, ~7at% Cu in Ag and ~6at% Ag in Cu are solved as calculated by Vegard's law).

The question of a possible temperature rise in operating shear bands is still under debate [46,47]. Nanoindentation measurements of the Cu₃₇Ag composite at different temperatures, Fig. 7b, have shown that at elevated temperatures the lamellar dual-phase regions have a lower hardness than the single-phase regions. Thus a temperature rise in the shear bands does not cause a softening in the shear bands compared to the nearby matrix. Additionally, a temperature rise during processing cannot exceed 70°C, because the hardness of the single- and dual-phase regions show no difference below this value; otherwise the deformation would preferentially take place in dual-phase regions only.

The very small differences in hardness and strain rate sensitivity together with the parallel orientation of the shear bands to the HPT shear plane led to a retardation of deformation in the lamellar regions by shear bands. In addition also an effect of a temperature rise was excluded, which could promote a transformation of retained lamellar regions. Therefore it seems that extremely high applied strains would be needed to reach a homogenous single-phase supersaturated solid solution.

5. Summary and conclusion

A Cu₃₇Ag composite was produced by powder compaction and HPT processing to a wide range of applied strains. The evolving microstructures were linked with changes in the hardness and the local deformation behavior. The following conclusions can be drawn:

- i. At applied shear strains below $\gamma \sim 100$ a lamellar composite is formed. In the separate Cu and Ag phases an UFG structure evolves by similar mechanisms as in severely plastically deformed pure metals. The grain refinement leads to an increase in hardness as in pure metals.
- ii. The lamella spacing reduces to the saturation grain size of pure Cu and Ag at $\gamma \sim 100$. Further thinning of them induces a strong increase in hardness. The microstructure is refined by uniform co-deformation of the Cu and Ag lamellae up to applied strains of $\gamma \sim 190$.
- iii. At $\gamma \sim 190$ shear band formation starts. The localized shear inclined to the lamella orientation in the shear bands leads to a strong refinement to a nanocrystalline dual-phase structure. New shear bands are formed continuously to accommodate the applied strain, thereby causing a rotation of the lamellae. With ongoing deformation a large volume fraction is deformed by shear bands resulting in an increase in hardness until saturation is reached. A complex balance between shear banding and co-deformation of Cu and Ag lamellae leads to an enormous refinement.
- iv. At $\gamma \sim 3800$ the major part of deformation is carried by shear bands running nearly parallel to the HPT shear plane, and slow down the homogenization process of the material. These shear bands in the hardness saturation regime accommodate very high

strains, leading to substantial mixing of Cu and Ag in the shear bands. The newly formed single-phase supersaturated solid solution maintains the global composition.

- v. The final obtained microstructure at room temperature is composed of supersaturated single- and lamellar Cu-Ag dual-phase regions.

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Figure 1: Schematic of the experimental procedure for split samples: a) the HPT disk is cut at a radius of $\sim 2 \text{ mm}$. b) cutting of FIB markers in the polished cross-section of the HPT disk. c) HPT disk deformed to an additional rotation of 15° ($\gamma \sim 1$).

Figure 2: Vickers hardness evolution with applied strain for pure Cu (powder and OFHC bulk material), pure Ag powder and Cu37Ag composite. For the Cu37Ag composite 4 samples deformed to 7, 20, 50 and 100 rotations are included in the analysis.

Figure 3: SEM images using back-scatter electrons in radial direction for different applied strains, Cu appears dark and Ag bright. a) For $\gamma \sim 18$ showing alternating Cu and Ag lamellae with spacing ranging from 100 nm to about 1 μm . b) At $\gamma \sim 190$ the first shear bands are observed under angles of $\sim 30^\circ$. c) At $\gamma \sim 380$ numerous shear bands run through the lamellar regions at angles of $\sim 10^\circ$ inducing a rotation of the lamellae orientation.

Figure 4: STEM bright field micrographs in radial direction for different applied strains. a) Fine-lamellar region with lamella thickness down to below 10 nm at $\gamma \sim 190$. b) A shear band running through the lamellar/UFG matrix at $\gamma \sim 380$, c) with EDX line scan indicated in the high-angle annular dark field STEM. Microstructure deformed to d) $\gamma \sim 1900$ and e) $\gamma \sim 3800$ showing an increase in regions deformed by shear bands. f) EDX line scan at $\gamma \sim 3800$ showing a chemical homogenization of the alloy.

Figure 5: a) TEM bright field image at $\gamma \sim 3800$ with a lamellar region in the upper half of the image and a region deformed by a shear band in the lower part of the image. b) Corresponding selected area electron diffraction (SAD) patterns (the areas contributing to the SAD patterns are indicated by circles in a)) for the lamellar and the shear band region. c) Azimuthal

distribution of SAD patterns of b) showing diffraction rings of Cu and Ag in the lamellar regions and a single-phase diffraction pattern for the shear band region; d) synchrotron X-ray measurements for $\gamma \sim 380$ and $\gamma \sim 1900$ showing the occurrence of a third phase in the diffraction pattern at $\gamma \sim 1900$.

Table 1: Results of synchrotron X-ray measurements showing the atomic percent of Cu calculated from lattice parameters, coherent domain sizes and root mean square strains for Cu, Ag and the supersaturated phase (ss-phase) of samples deformed to 5, 10, 50 and 100 rotations, corresponding to applied strains of $\gamma \sim 190$, 380, 1900 and 3800, respectively. Numbers in parentheses represent the errors.

Sample	Shear strain	Atomic percent of Cu			Coherent domain size, L (Å)			Root mean square strain, $\langle \epsilon^2 \rangle^{1/2}$ (10^{-3})		
		Ag	SS phase	Cu	L _{Ag}	L _{SS phase}	L _{Cu}	$\langle \epsilon^2 \rangle_{Ag}^{1/2}$	$\langle \epsilon^2 \rangle_{ss\ phase}^{1/2}$	$\langle \epsilon^2 \rangle_{Cu}^{1/2}$
5 rotations	190	0		100	23,8 (8,2)	-	31,1 (14,7)	1.6 (4.0)	-	0.6 (9)
10 rotations	380	0		100	14,9 (3,2)	-	28,9 (12,7)	-		1.8 (3.0)
50 rotations	1900	7,8	66	95	4,6 (0,3)	3,4 (0,2)	8,5 (1,1)	6.2 (1.0)	23 (0.2)	5.8 (1.0)
100 rotations	3800	6,8	62	94	4,1 (0,2)	4,2 (0,3)	11,2 (1,9)	7.2 (0.8)	17 (0.3)	8.9 (0.7)

Figure 6: SEM images using back-scatter electrons of the split samples. a) $\gamma\sim 125+1$, the FIB grid is in general uniformly sheared, but local variations are seen. b) Detail of a) revealing regions that sheared uniformly and strong local deformation of broader retained Cu and Ag lamellae. c) $\gamma\sim 250+0.35$ with several shear bands shifting the FIB grid. d) detail of c) showing a shear band, which displaced the FIB grid of about 2 μm and an inactive shear band marked by an arrow. e) detail of uniformly sheared regions of c). f) $\gamma\sim 1250+1$, showing a combination of shear bands and uniform shear of the grid. g) $\gamma\sim 1250+1$, the grid is displaced mainly at three positions by shear bands (marked with arrows). h) $\gamma\sim 2500+1$, the deformation is mainly carried by shear bands.

Figure 7: Nanoindentation measurements for single-phase and dual-phase regions. a) Nanoindentation hardness at different temperatures. Strain-rate jump tests at room temperature, c) Hardness, strain rates are indicated, and Young's modulus as inset.

Figure 8: Stages in the hardening of the Cu37Ag composite. A: formation and saturation of an UFG structure in the separate Cu and Ag lamellae, B: Cu and Ag lamellae have reached thicknesses in the range of their respective saturation grain sizes, further co-deformation of Cu and Ag lamellae referred to as dual-phase refinement. C: occurrence of shear bands causing further dual-phase refinement and a rotation of the lamellae. D: localized saturation: deformation is mainly limited to shear bands, in which a single-phase supersaturated solid solution is formed.